

1N5807CBUS thru 1N5811CBUS

SURFACE MOUNT VOIDLESS-HERMETICALLY-SEALED ULTRA FAST **RECOVERY GLASS RECTIFIERS**

	DESCRIPTION APPEARANCE This "Ultrafast Recovery" surface mount rectifier diode series is military qualified to MIL- PRF-19500/742 and is ideal for high-reliability applications where a failure cannot be Image: Comparison of the provided series is military qualified to MIL- present the provided series is military qualified to										
	tolerated. These industry-recognized 6.0 Amp rated rectifiers for working peak reverse voltages from 50 to 150 volts are hermetically sealed with voidless-glass construction using an internal "Category III" metallurgical bond. These devices are also available in axial-leaded package configurations (see separate data sheet for 1N5807CB thru 1N5811CB). Microsemi also offers numerous other rectifier products to meet higher and lower current ratings with various recovery time speed requirements including standard, fast, and ultrafast device types in both through-hole and surface mount packages.					ng al- b). nt	Pack or D	kage "E" 9-5B			
, IN	PORTANT: Fo		rrent data, consult	MICROSEMI's	website: http	<u>://www.r</u>					
		F	EATURES				AP	PLIC	ATION	IS / BENE	FITS
•	 Surface mount package series equivalent to the JEDEC registered 1N5807 to 1N5811 series Voidless-hermetically-sealed glass package Extremely robust construction Triple-layer passivation Internal "<i>Category III</i>" Metallurgical bonds JAN, JANTX, & JANTXV available per MIL-PRF-19500/742 Further screening options are available for JANS in accordance with MIL-PRF-19500/742 by using a "SP" prefix Axial-leaded equivalents also available (see separate data sheet for 1N5807CB thru 1N5811CB) MAXIMUM RATINGS Operating Temperature: -65°C to +175°C. Storage Temperature: -65°C to +175°C. Average Rectified Forward Current (I₀): 6 Amps @ T_{EC} = 75°C End Cap temperature (see note 1) Thermal Resistance: 6.5 °C/W junction to end cap Thermal Impedance: 1.5 °C/W @ 10 ms heating time Forward Surge Current (8.3 ms half sine) 125 Amps Capacitance: 60 pF at 10 volts, f = 1 MHz Solder temperature: 260°C for 10 s (maximum) 			500/742 P" prefix te data	 Ultrafast recovery 6 Amp rectifier series 50 to 150V Military and other high-reliability applications Switching power supplies or other applications requiring extremely fast switching & low forward loss High forward surge current capability Low thermal resistance Controlled avalanche with peak reverse power capability Inherently radiation hard as described in Microsemi MicroNote 050 MECHANICAL AND PACKAGING CASE: Hermetically sealed voidless hard glass with Tungsten slugs TERMINALS: End caps are Copper with Tin/Lead (Sn/Pb) finish. MARKING & POLARITY: Cathode band only Tape & Reel option: Standard per EIA-481-B Weight: 539 mg See package dimensions and recommended pad 						
	ELECTRIC		RACTERISTI	CS		•	layout o				
٢	ТҮРЕ		BREAKDOWN VOLTAGE (MIN.) @ 100µA V _{BR}		AVERAGE RECTIFIED CURRENT I _{O2} @T _A =55°C (Note 2)	FORV VOLT @ (8.3 ms	MUM VARD FAGE 4 A s pulse) / _F	CUR (M @ ۱	ERSE RENT AX) / _{RWM} I _R	SURGE CURRENT (MAX) I _{FSM} (NOTE 3)	REVERSE RECOVERY TIME (MAX) (NOTE 4) t _{rr}
		VOLTS	VOLTS	AMPS	AMPS	VOL				AMPS	ns
	1N5807CBUS	50	60	6.0	3.0	25°C 0.875	100°C 0.800	25°C	125°C 525	125	30
	1	1	1			1	1	1			

1N5811CBUS 160 3.0 150 6.0 **NOTE 1:** Rated at T_{EC} = 75°C. Derate at 60 mA/°C for T_{EC} above 75°C

110

NOTE 2: Derate linearly at 25 mA/°C above T_A = 55°C. This rating is typical for PC boards where thermal resistance from mounting point to ambient is sufficiently controlled where $T_{J(\text{max})}$ does not exceed 175^{o}C

0.875

0.875

0.800

0.800

5

5

525

525

125

125

3.0

NOTE 3: $T_A = 25^{\circ}C \otimes I_0 = 3.0 \text{ A}$ and V_{RWM} for ten 8.3 ms surges at 1 minute intervals

6.0

NOTE 4: $I_F = 1.0 \text{ A}$, $I_{RM} = 1.0 \text{ A}$, $I_{R(REC)} = 0.10 \text{ A}$ and di/dt = 100 A/µs min

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1N5809CBUS

Microsemi Scottsdale Division

N5807CBUS-1N5811CBUS

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100

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1N5807CBUS thru 1N5811CBUS

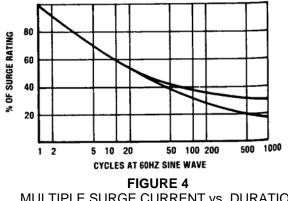
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	SYMBOLS & DEFINITIONS							
Symbol	Definition							
V _{BR}	Minimum Breakdown Voltage: The minimum voltage the device will exhibit at a specified current.							
V _{RWM}	Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating temperature range.							
V _F	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.							
	Maximum Leakage Current: The maximum leakage current that will flow at the specified voltage and							
I _R	temperature.							
С	Capacitance: The capacitance in pF at a frequency of 1 MHz and specified voltage							
	Reverse Recovery Time: The time interval between the instant the current passes through zero when							
t _{rr}	changing from the forward direction to the reverse direction and a specified recovery decay point after a peak reverse current is reached.							
	GRAPHS							
TYPIC/ vs.	$\frac{1}{115\%} + \frac{1}{100\%} + 1$							
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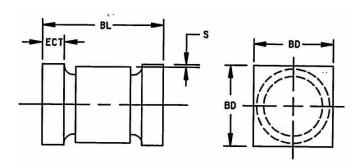
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MULTIPLE SURGE CURRENT vs. DURATION

PACKAGE DIMENSIONS AND PAD LAYOUT

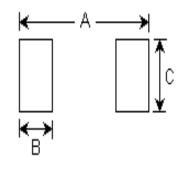


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NOTE: This Package Outline has also previously been identified as "D-5B"

	INCHES		mm			
	MIN	MAX	MIN	MAX		
BL	.205	.225	5.21	5.72		
BD	.137	.142	3.48	3.61		
ECT	.019	.028	0.48	0.711		
S	.003		0.08			



PAD LAYOUT

	INCHES	mm			
Α	0.288	7.32			
В	0.070	1.78			
С	0.155	3.94			
Note: If mounting requires adhesive					
separate from the solder, an additional					
0.080 inch diameter contact may be					
placed in the center between the pads					
as an optional spot for cement.					

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